

PATENT ASSIGNMENT

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NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Stefan Illek	04/19/2011
Uwe Strauss	04/19/2011
RECEIVING PARTY DATA	
Name:	OSRAM Opto Semiconductors GmbH
Street Address:	Leibnizstrasse 4
City:	Regensburg
State/Country:	GERMANY
Postal Code:	93055
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13123779
CORRESPONDENCE DATA	
Fax Number:	(215)656-2498
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	215-656-3381
Email:	pto.phil@dlapiper.com
Correspondent Name:	T. Daniel Christenbury
Address Line 1:	One Liberty Place
Address Line 2:	1650 Market Street, Suite 4900
Address Line 4:	Philadelphia, PENNSYLVANIA 19103
ATTORNEY DOCKET NUMBER:	EHF-11-1110
NAME OF SUBMITTER:	Carol Coney
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P2008.1276 US N / 2115 / 2008P24446WOUS (SG/MH)

ASSIGNMENT

WHEREAS, we, Stefan Illek and Uwe Strauss, citizens of Austria and Germany, respectively, residing at Bayerwaldstraße 45, 93093 Donaustauf, Germany and Erich-Kästner-Straße 32, 93077 Bad Abbach, Germany, respectively, (hereinafter referred to as "the undersigned"), having made an invention entitled OPTOELECTRONIC SEMICONDUCTOR CHIP AND METHOD OF PRODUCING AN OPTOELECTRONIC SEMICONDUCTOR CHIP, identified in International Application No. PCT/DE2009/001416, and in US Application No. 13/123,779, (DLA Piper is authorized to insert the Serial No. when known),

WHEREAS, OSRAM Opto Semiconductors GmbH, with offices located at Leibnizstrasse 4, 93055 Regensburg, Germany (hereinafter referred to as "the assignee"), is desirous of acquiring the entire right, title and interest in said invention, said US application and all letters patent issuing for said invention,

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and of other good and valuable consideration, receipt of which is hereby acknowledged, the undersigned, intending to be legally bound, do hereby sell, assign and transfer to the assignee the entire right, title and interest, for the United States of America, its territories and possessions, and for all foreign countries, in said invention, including said US application, all divisions and continuations thereof, all rights to claim priority based thereon, all rights to file foreign applications on said invention, and all letters patent and reissues thereof, issuing for said invention in the United States of America and in any and all foreign countries.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the undersigned has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the assignee, and to execute all instruments proper to carry out the intent of this instrument. If the undersigned includes more than one individual, these obligations shall apply to all of the undersigned both individually and collectively.

The rights and property herein conveyed by the undersigned are free and clear of any encumbrance.

EXECUTED on the date(s) set forth below:

Apr. 19th 2011

Date

Apr 19th 2011

Date

Stefan Illek

Stefan Illek

Uwe Strauss

Uwe Strauss

PATENT

GESAMTSEITEN 005